

Product Change Notification PCN96001

A change in the Xilinx XC3100 Fabrication Process

Subject: A Change in the Xilinx XC3100 Fabrication Process.

Products Affected: XC3120A (a new product), XC3130A, XC3142A, XC3164A, XC3190A, and XC3195A.

Note: Please see [PDN97006](#) for the latest status.

Change Description: The above products will be manufactured in the 0.6 μ M triple layer metal CMOS process now in production at Seiko Epson. This is the same process that is used to manufacture the XC4000E and XC5200 lines of product.

Reason for Change: This change is being made both to increase the availability of higher speed grades of these products, and to continue the Xilinx program of evolutionary price reductions.

Qualification Data: Qualification data on sample members of this family, along with data from other product families is attached.

Traceability: The product marking code can be used to determine the mask generation of a particular product. Product fabricated in the Seiko 0.6 μ M triple layer metal CMOS process carries the geometry code "J". Please contact your sales representative if you wish a copy of IVC0015, which lists these production codes.

Key Dates: Qualification samples of XC3130A, XC3142A, XC3164A, XC3190A, & XC3195A manufactured with this process are available now. Samples of the XC3120A will be available in May. The dates for last buy and last guaranteed availability of the older Seiko product (0.8 μ M) are 180 days and 360 days respectively after receipt of this notice.

Response: No response to this notification is required. Requests for additional data or support should be made within 90 days of notification. Please address any questions you may via email at "pcn@xilinx.com" or directly by fax at 408 559 1368.